# Open Kit Project

# **Description of Physical Design Rules and Technology**

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#### Purpose and scope

This document specifies a method of describing physical design rules and technology as needed by custom design tools. The organization of topics follows the OpenKit Design Objective document. The Advanced Library Format [IEEE std 1603-2003] is used as a description vehicle for each topic.

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# **1.0 Layer information**

This section specifies how to describe layer types and purpose, layer sourcing and naming.

### 1.1 Layer terminology

TABLE 1. Layer	terminology
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Term	Explanation	Comment
Layer	A surface in the x-y plane, subject to description of layout geometry	
Layer, fabricated	A layer wherein layout geometry is created using a silicon manufacturing process technology, by selectively depositing and/or removing material on the surface.	
Layer, virtual	A layer wherein geometry is described for the pur- pose of expressing relationships and/or constraints between other layout geometries. A virtual layer is not fabricated.	
Layer type, layer purpose, layer sourcing	A way of classifying layers from an application standpoint	
Layer naming	A way of identifying a layer, including the capabil- ity to refer to a layer by name.	

### **1.2 Layer description in ALF**

A *layer* (see IEEE Std 1603-2003, 8.16) is declared as a named object within a technology *library* (see IEEE Std 1603-2003, 8.2). The layer which is fabricated first, i.e., the layer closest to the silicon substrate, is declared first. A virtual layer is declared after the declaration of the uppermost fabrication layer.

#### FIGURE 1. Layer declaration template in ALF

```
LIBRARY <libraryname> {
   /* put global information (e.g. units) here */
   LAYER <layername> {
     LAYERTYPE = <layertype> ;
     /* put layer-specific information
     (detailed in other sections) here */
   }
}
```

In the ALF template, libraryname> and <layername> are placeholders for the actual name of the library (e.g. my90nm) and the layer (e.g. poly, metal1, cut12), respectively.

The <layertype> is the placeholder for a keyword specifying the purpose of a layer. The predefined ALF keywords (see IEEE Std 1603-2003, 8.17.2) are listed below.

<layertype></layertype>	Explanation	Comment
routing	a fabricated layer providing electrical connections within a plane	
cut	a fabricated layer providing electrical connections between planes	
substrate	a fabricated layer at the bottom	
dielectric	a fabricated layer providing electrical isolation	
reserved	a fabricated layer wherein the geometry cannot be changed by the layout designer	
abstract	a virtual layer	

 TABLE 2. Layertype in ALF

A typical sequence of layer types might be *substrate*, *reserved*, *routing*, (one or more) *dielectric*, *cut*, *dielectric* (one or more), *routing*, (one or more) *dielectric*, *cut*, etc., followed by (one or more) *abstract*.

# 2.0 Layer and Structure Specification

# 2.1 Layer and structure terminology

Term	Explanation	Comment
via	a predefined structure of geometries for electrical connection between layers	
electrical characteristics of a layer or a structure	calculation rule for resistance and capacitance involving the layer or structure	
physical characteristics of a layer or a structure	geometric measurements involving the layer or structure	

TABLE 3. Layer and structure terminology

### 2.2 Layer and structure description in ALF

The electrical and physical characteristics of a layer are described within the context of the layer declaration (see Figure 1 on page 3). The quantities describing electrical characteristics are *resistance* and *capacitance*. The quantities describing physical characteristics are *thickness* and *height*. A quantity can be a single number, a discrete set of numbers, a continuous range of numbers, or a function of another quantity. All these descriptions use the *arithmetic model* construct (see IEEE Std 1603-2003, 10.3), which supports a scalar value, a *table* of values with an associated *interpolation* scheme, or an *arithmetic expression*.

Keyword	usage	See IEEE Std 1603-2003
CAPACITANCE	describe capacitance of a layer as a function of width, length, or area	10.15.3
RESISTANCE	describe resistivity of a layer, i.e., resistance as a function of width, length, or area	10.15.4
THICKNESS	describe the thickness of a layer	10.19.5
HEIGHT	describe the height of a layer above the substrate	10.19.6

TABLE 4. Quantities for electrical and physical characteristics of a layer

A *via* (see IEEE Std 1603-2003, 8.18) is declared as a named object within a technology *library* (see IEEE Std 1603-2003, 8.2). It is a predefined set of geometries, each of which is defined as a *pattern* (see IEEE Std 1603-2003, 8.29).

A *pattern* is a geometry or a collection of geometries associated with a particular layer (referenced by <layername>). The geometry of a pattern is described using the *geometric model* construct (see IEEE Std 1603-2003, 9.16), which features the exact coordinates of the geometry.

#### FIGURE 2. Via template in ALF

```
LIBRARY <libraryname> {
    /* put global information (e.g. units) here */
    /* put layer declarations here */
    VIA <vianame> {
        VIATYPE
        PATTERN <patternname> {
           LAYER = <layername> {
               /* put geometric description of the pattern here */
        }
        /* put more pattern declarations here */
    }
```

A via declaration typically consists of three patterns, involving two adjacent routing layers and the cut layer in-between. A stacked via can involve five, seven, or more patterns.

The <viatype> is the placeholder for a keyword specifying the purpose of a via. The predefined ALF keywords (see IEEE Std 1603-2003, 8.19.2) are listed below.

<viatype></viatype>	Explanation	Comment
default	via can be used freely	
non-default	usage of the via is constraint by a rule (see Section 3.2 on page 7)	
partial_stack	via is used to construct a stacked via	
full_stack	via describes the full stack	

TABLE 5. Viatype in ALF

# **3.0 Design rule description**

### **3.1 Design rule terminology**

Term	Explanation	Comment
Design rule	A constraint and/or a limit for measurable quantity related to a design object.	
Design rule, geometric	A constraint/limit for length/width/height/ area/perimeter of an object or for distance/ overhang between objects.	
Design rule, electrical	A constraint for connectivity between objects. A violation of the rule will lead to electrical malfunction of a circuit.	
Design rule, reliability	A constraint/limit for geometry, electrical cur- rent or other quantity imposed by electromi- gration or other stress. A violation of the rule will shorten the lifetime of a circuit.	
Design rule, manufacturability	A constraint/limit for geometry imposed by manufacturing, such as process antenna, pat- tern density, litography. A violation of the rule will reduce the yield of a fabricated circuit.	

#### TABLE 6. Design rule terminology

# **3.2 Design rule description in ALF**

The description of a design rule depends on the type of objects involved. A rule involving only one particular object, for example a *layer*, can be described within the declaration of the object (see also Figure 1 on page 3).

#### FIGURE 3. Template for layer-specific design rule in ALF

```
LIBRARY <libraryname> {
   /* put global information (e.g. units) here */
   LAYER <layername> {
     LAYERTYPE = <layertype> ;
     LIMIT <quantity> {
        /* put measurement definition of the quantity here */
        MIN {
            /* put calculation rule for lower limit here */
        }
        MAX {
            /* put calculation rule for upper limit here */
        }
    }
}
```

A design rule involving multiple objects is described by declaring a *rule* (see IEEE Std 1603-2003, 8.20) as a named object within a technology *library*. Within the rule, other named objects, such as a *pattern*, a *region*, or an instance of a *via*, are declared. Constraints and limits involving measurable quantities related to those objects (e.g. *distance* between two patterns, *area* of a region) are then described.

#### FIGURE 4. Design rule template in ALF

```
LIBRARY <libraryname> {
   /* put global information (e.g. units) here */
   /* put layer declarations here */
   /* put via declarations here */
   RULE <rulename> {
      PATTERN <patternname> {
        LAYER = <layername> ; /* reference to a declared layer */
         /* put geometric description of the pattern here */
      }
      <vianame> <viainstancename> { /* via must be declared before */
         /* put location of the via instance here */
      REGION <regionname> {
         /* put geometric description of the pattern here */
      LIMIT <quantity> {
         /* put measurement definition of the quantity here */
         MIN {
            /* put calculation rule for lower limit here */
         }
         MAX {
            /* put calculation rule for upper limit here */
      }
  }
}
```

A *pattern* (see IEEE Std 1603-2003, 8.29) is a geometry or a collection of geometries associated with a particular layer (referenced by <layername>).

A *region* (see IEEE Std 1603-2003, 8.31) is a geometry or a collection of geometries encompassing all layer geometries within the boundaries of the region.

The geometry of a pattern or a region is described using the *geometric model* construct (see IEEE Std 1603-2003, 9.16), which features the exact coordinates of the geometry. Alternatively, a routing geometry (i.e. a pattern related to a layer with layertype *routing*) can be described in a more abstract way using the *shape*, *vertex*, and *route* annotation (see IEEE Std 1603-2003, 8.30.2, 8.30.3, 8.30.4).

The calculation rule for the quantity subject to the design rule is described using the *arithmetic model* construct (see IEEE Std 1603-2003, 10.3). This construct supports a scalar value, a *table* of values with an associated *interpolation* scheme, or an *arithmetic expression*.

A design rule for reliability use the same template as a design rule for geometry, only the quantity is electrical *current*, as opposed to a geometric quantity *length*, *width*, *distance*, or *overhang*. However, the limit for electrical current can be a function of a geometric quantity.

The quantities length, distance, and overhang need to be described in a *rule* context. The quantities width and current can be described in a *layer* context, if no other objects than the layer are involved. Otherwise, they also need to be described in a rule context.

Keyword	usage	measurement definition	See IEEE Std 1603-2003
CURRENT	electrical current traversing an	MEASUREMENT annotation	10.15.2
	object	(average, absolute average, rms, peak)	10.13.7
		reference to a PATTERN, if in RULE context	
WIDTH	width of a routing segment	none, if in LAYER context	10.19.7
		reference to a PATTERN, if in RULE context	
LENGTH	length of a routing segment	reference to a PATTERN	10.19.8
	common run length between two routing segments	BETWEEN construct involv- ing two objects of type PAT- TERN	10.20.4

Keyword	usage	measurement definition	See IEEE Std 1603-2003
DISTANCE	distance between two objects	BETWEEN construct involv- ing two objects of type PAT- TERN, REGION, or via instance	10.19.9 10.20.4 10.20.5 10.20.6
		MEASURE annotation (euclidian, manhattan, hori- zontal, vertical)	
		REFERENCE annotation con- tainer	
OVERHANG	overhang between two objects	BETWEEN construct involv- ing two objects of type PAT- TERN	10.19.10 10.20.4

TABLE 7. Quantities for design rule descriptions

# 4.0 Other items

### 4.1 Other terminology

#### TABLE 8. Other terminology

Term	Explanation	Comment
unit	description of measurement units for geometric and electrical quantities	
layer visualization		
grid representation		
non-rectilinear geometry		
mask options		

# 4.2 Other description in ALF

FIGURE 5. Other template in ALF

```
LIBRARY <libraryname> {
    /* put global information (e.g. units) here */
    /* put layer declarations here */
    /* put declaration of other objects (e.g. vias) here */
}
```